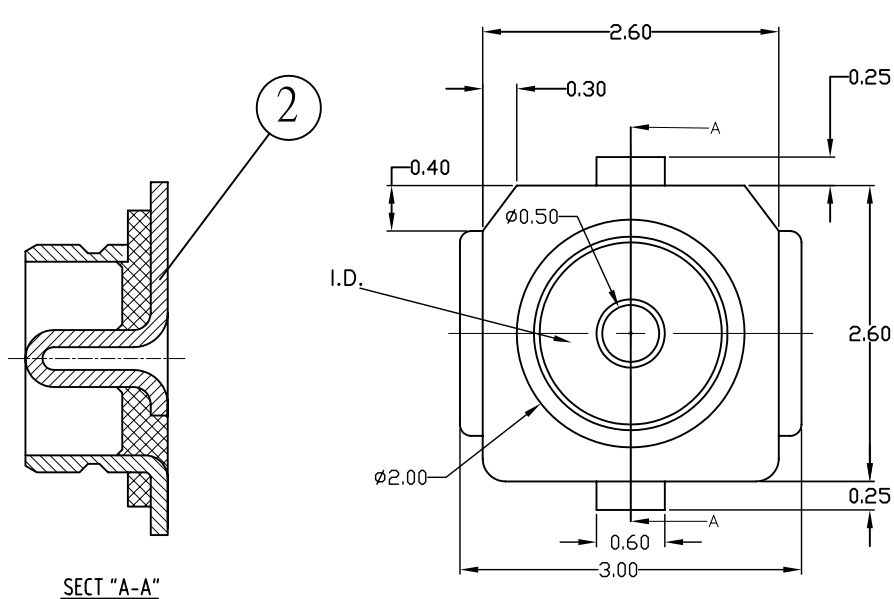
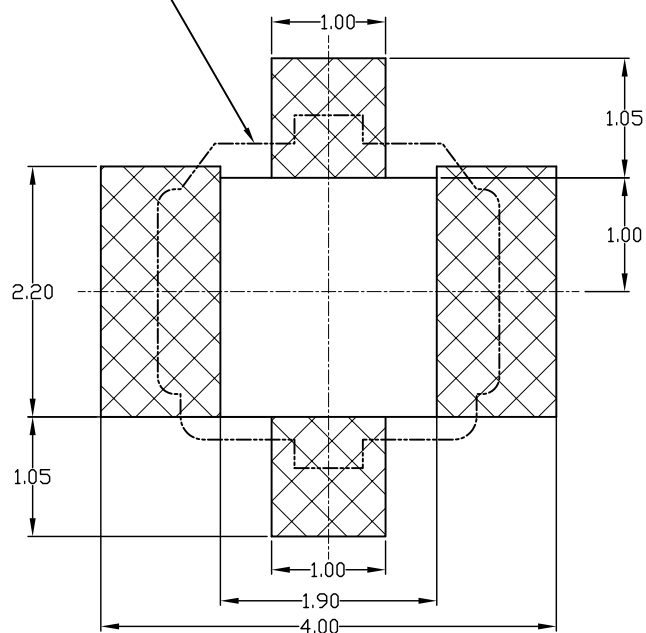


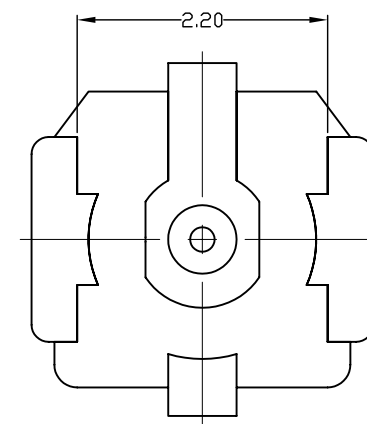
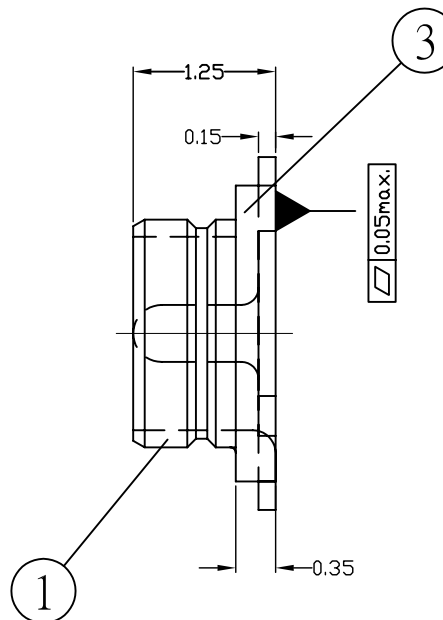


SECT "A-A"

CONNECTOR OUTLINE



RECOMMENDED FOOTPRINT PATTERN



PART NUMBER : YMX0681XXX

01=CONTACT AREA GOLD PLATED 1u"
03=CONTACT AREA GOLD PLATED 3u"
05=CONTACT AREA GOLD PLATED 5u"

GROUND CONTACT PLATED
0=Au
8=Ag

Material

1. Contact: Copper alloy, Brass per JIS C2680 or other equivalent copper alloy.
2. Ground contact: Copper alloy, Ph. Bronze per JIS C5191 or other equivalent.
3. Housing: LCP resin with 30% G.F. filled, UL94v-0.
4. Finish: (plating thickness)
Contact :Au plating over 50u" Nickel under plating.
Ground contact: Au flash over 50u" Nickel under plating.
or Ag 100u" over 10u" Nickel under plating.

Remove burrs, Break sharp edges 0.4
R. max.
Stamp part no. in area indicated by "x"
Unless otherwise specified
Angle: $\pm 1^\circ$

XX.XX = ± 0.20

XX.XXX = ± 0.10

A	設計發行	CHEN 05/05/2007	P/ NO :	YMX0681XXX
		TITLE	Micro Coaxial RF receptacle 4P	
SHEET	1 / 1	App. Date	Chk. Date	Drf. Date
SCALE	1 : 1	CHEN 05/05/2007	CHEN 05/05/2007	CHEN 05/05/2007
譽盛精密工業股份有限公司				